



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Cobbley et al.

Serial No.: 10/721,110

Filed: November 24, 2003

For: METHOD FOR IN-LINE TESTING
OF FLIP-CHIP SEMICONDUCTOR
ASSEMBLIES

Confirmation No.: 6106

Examiner: R. Kober

Group Art Unit: 2829

Attorney Docket No.: 2269-3437.9US
(97-0514.09/US)

Notice of Allowance Mailed:

June 28, 2005

CERTIFICATE OF MAILING

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Leta M. Howard
Name (Type/Print)

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Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Abstract appear on page 6 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 7 of this paper.

Remarks begin on page 9 of this paper.